Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L5	1	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 (thick or thickness) near10 mil).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:13
L6	459	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:13
L7	1	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink)).clm. and ((encapsulant or epoxy or resin) near10 (thick or thickness) near10 mil).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:14
L8	6	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink)).clm. and ((encapsulant or epoxy or resin) near10 (thick or thickness) near10 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:14
L9	63	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink)) and ((encapsulant or epoxy or resin) near10 (thick or thickness) near10 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:14
L10	43	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink)) and ((encapsulant or epoxy or resin) near5 (thick or thickness) near10 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:14
L11	20	((encapsulant or epoxy or resin) near5 (spreader or slug or sink or heatsink)) and ((encapsulant or epoxy or resin) near5 (thick or thickness) near10 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:14
L12	19	((encapsulant or epoxy or resin) near5 (spreader or slug or sink or heatsink)) and ((encapsulant or epoxy or resin) near5 (thick or thickness) near5 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:15
L13	2	((encapsulant or epoxy or resin) near5 (spreader or slug or sink or heatsink) near5 die) and ((encapsulant or epoxy or resin) near5 (thick or thickness) near5 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:16

L14	10	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near5 die) and ((encapsulant or epoxy or resin) near5 (thick or thickness) near5 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:16
L15	15	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die) and ((encapsulant or epoxy or resin) near5 (thick or thickness) near5 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:16
L16	17	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die) and ((encapsulant or epoxy or resin) near10 (thick or thickness) near5 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:16
L17	17	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die) and ((encapsulant or epoxy or resin) near10 (thick or thickness) near10 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:17
L18	1	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die).clm. and ((encapsulant or epoxy or resin) near10 (thick or thickness) near10 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:18
L19	8	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die).clm. and ((encapsulant or epoxy or resin) near10 (thick or thickness))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:22
L20	93	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die) and ((encapsulant or epoxy or resin) near10 (thick or thickness))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:19
L21	13	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die) with ((encapsulant or epoxy or resin) near10 (thick or thickness))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:20
L22	507	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:22

L23	224	((encapsulant or epoxy or resin) near5 (spreader or slug or sink or heatsink) near5 die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:22
L24	20	((encapsulant or epoxy or resin) near5 (spreader or slug or sink or heatsink) near5 die).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:28
L25	34	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:32
L26	0	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die near10 (completely or fully) near10 (cover or covering or covered))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:32
L27	23	((encapsulant or epoxy or resin) near10 (spreader or slug or sink or heatsink) near10 die near10 (cover or covering or covered))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:32
L28	13	((encapsulant or epoxy or resin) near2 (cover or covering or covered) near10 (spreader or slug or sink or heatsink) near10 die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:35
L29	53	((encapsulant or epoxy or resin) near2 (cover or covering or covered) near10 (spreader or slug or sink or heatsink) near10 (chip or die))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:36
L30	0	((encapsulant or epoxy or resin) near2 (cover or covering or covered) near2 (completely of fully) near10 (spreader or slug or sink or heatsink) near10 (chip or die))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:36
L31	53	((encapsulant or epoxy or resin) near2 (cover or covering or covered) \near10 (spreader or slug or sink or heatsink) near10 (chip or die))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:36
L32	53	((encapsulant or epoxy or resin) near2 (cover or covering or covered) near10 (spreader or slug or sink or heatsink) near10 (chip or die))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:36

L33	14	((encapsulant or epoxy or resin) near2 (cover or covering or covered) near10 (spreader or slug or sink or heatsink) near10 (chip or die)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:37
L34	53	((encapsulant or epoxy or resin) near2 (cover or covering or covered) near10 (spreader or slug or sink or heatsink) near10 (chip or die))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:39
L35	0	((encapsulant or epoxy or resin) near2 (cover or covering or covered) near2 (fully or completely) near2 (spreader or slug or sink or heatsink))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:39
L36	4	((encapsulant or epoxy or resin) near5 (cover or covering or covered) near5 (fully or completely) near5 (spreader or slug or sink or heatsink))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:50
L37	2	(spreader or slug or heatsink) near5 (epoxy or resin) near5 (thick or thickness) near5 mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:48
L38	2	(spreader or slug or heatsink) near10 (epoxy or resin) near10 (thick or thickness) near10 mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:48
L39	2	(spreader or slug or heatsink) near10 (epoxy or resin) near10 mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:49
L40	9	(spreader or slug or heatsink or sink) near10 (epoxy or resin) near10 mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:49
L41	1	((spreader or slug or heatsink or sink) near10 (epoxy or resin) near10 mil).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:50
L42	9	((spreader or slug or heatsink or sink) near10 (epoxy or resin) near10 mil)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:50

L43	7	((encapsulant or epoxy or resin) near10 (cover or covering or covered) near10 (fully or completely) near10 (spreader or slug or sink or heatsink))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:51
L44	143	(encapsulant or resin or epoxy) near5 (spreader or sink or heatsink) near5 (thick or thickness)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:52
L45	1	(encapsulant or resin or epoxy) near5 (cover or covering) near5 (spreader or sink or heatsink) near5 (thick or thickness)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:52
L46	10	(encapsulant or resin or epoxy) near10 (cover or covering) near10 (spreader or sink or heatsink) near10 (thick or thickness)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:53
L47	287	(encapsulant or resin or epoxy) near10 (cover or covering) near10 (spreader or sink or heatsink)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:53
L48	161	(encapsulant or resin or epoxy) near5 (cover or covering) near5 (spreader or sink or heatsink)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:53
L49	15	((encapsulant or resin or epoxy) near5 (cover or covering) near5 (spreader or sink or heatsink)). clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:53

| L50 | 87 | (US-20020109226-$ or US-20020171144-$ or US-20020185717-$ or US-20040055152-$ or US-20030102537-$ or US-20020056856-$ or US-20010030355-$ or US-20040099933-$ or US-20020048825-$ or US-20050146021-$ or US-20040238944-$ or US-20040063360-$ or US-20030038382-$ or US-20020074627-$ or US-20010000924-$ or US-20050012203-$ or US-20040100832-$ or US-20030066679-$ or US-20010041370-$).did. or (US-4692791-$ or US-5383787-$ or US-5533256-$ or US-5552635-$ or US-5616957-$ or US-5638597-$ or US-5789813-$ or US-5977626-$ or US-6008991-$ or US-6069023-$ or US-6117352-$ or US-6163458-$ or US-6225695-$ or US-6400014-$ or US-6429513-$ or US-6433420-$ or US-6449748-$ or US-6504723-$ or US-6507104-$ or US-5800958-$ or US-6383843-$ or US-5986885-$ or US-5566051-$ or US-5543664-$ or US-5420751-$ or US-5279029-$).did. or (US-4810563-$ or US-4667219-$ or US-6315004-$ or US-5877043-$ or US-5854085-$ or US-5801432-$ or US-5760465-$ or US-6242281-$ or US-6229200-$ or US-6171888-$ or US-5763952-$ or US-5681777-$ or US-5639385-$ or US-5638596-$ or US-5552631-$ or US-5550406-$ or US-5376909-$ or US-4783428-$ or US-6437984-$ or US-6429028-$ or US-5722161-$ or US-5701034-$ or US-5455462-$ or US-6906413-$ or US-6724071-$ or US-6552417-$ or US-6326678-$).did. or (US-4132856-$ or US-6853070-$ or US-6552428-$ or US-6262480-$ or US-5935502-$ or US-5870012-$ or US-5734201-$ or US-6028354-$).did. or (JP-06061400-$).did. or (GB-2218570-$ or US-6117797-$ or US-4783428-$ or JP-2002252319-$ or JP-2001300955-$ or US-60491?? -$).did. | US-PGPUB; USPAT; JPO; DERWENT | OR | ON | 2005/07/24 14:55 |

L51	31	I50 and (thick or thicker or thickness).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:56
L52	4	I50 and (thick or thicker or thickness) near5 (epoxy or resin or encapsulant).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:56
L53	4	I50 and ((thick or thicker or thickness) near5 (epoxy or resin or encapsulant)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:57
L54	51	I50 and ((thick or thicker or thickness) near5 (epoxy or resin or encapsulant))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:57
L55	15	I50 and ((thick or thicker or thickness) near (epoxy or resin or encapsulant))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:57
L56	6	I50 and ((thick or thicker or thickness) near (epoxy or resin or encapsulant)) and mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:58
L57	5	I50 and ((thick or thicker or thickness) near (epoxy or resin or encapsulant)) with mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:58
L58	5	I50 and ((thick or thicker or thickness) near (epoxy or resin or encapsulant)) near10 mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:59
L59	367	((thick or thicker or thickness) near (epoxy or resin or encapsulant)) near10 mil	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:59
L60	1	((thick or thicker or thickness) near (epoxy or resin or encapsulant)) near10 mil near10 (heatsink or spreader or slug or sink)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 14:59

L61	11	((thick or thicker or thickness) near10 (epoxy or resin or encapsulant)) near10 mil near10 (heatsink or spreader or slug or sink)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/24 15:01